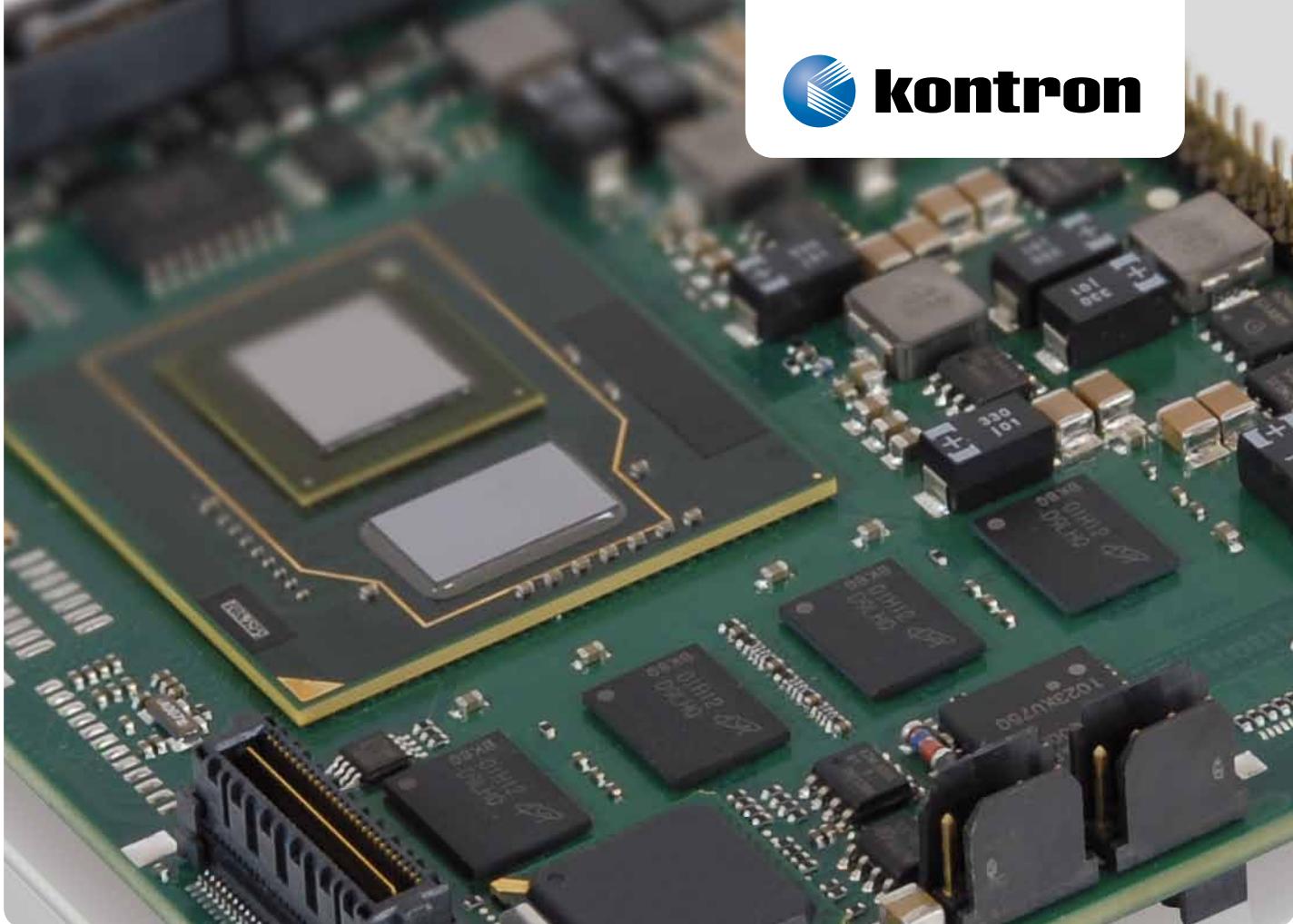




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» MICROSPACE® Single Board Computers and Box PCs «

- » PC/104™, PC/104-Plus™,
PCI/104-Express™, PCIe/104™
- » Ruggedized Box PCs



If it's embedded, it's Kontron.

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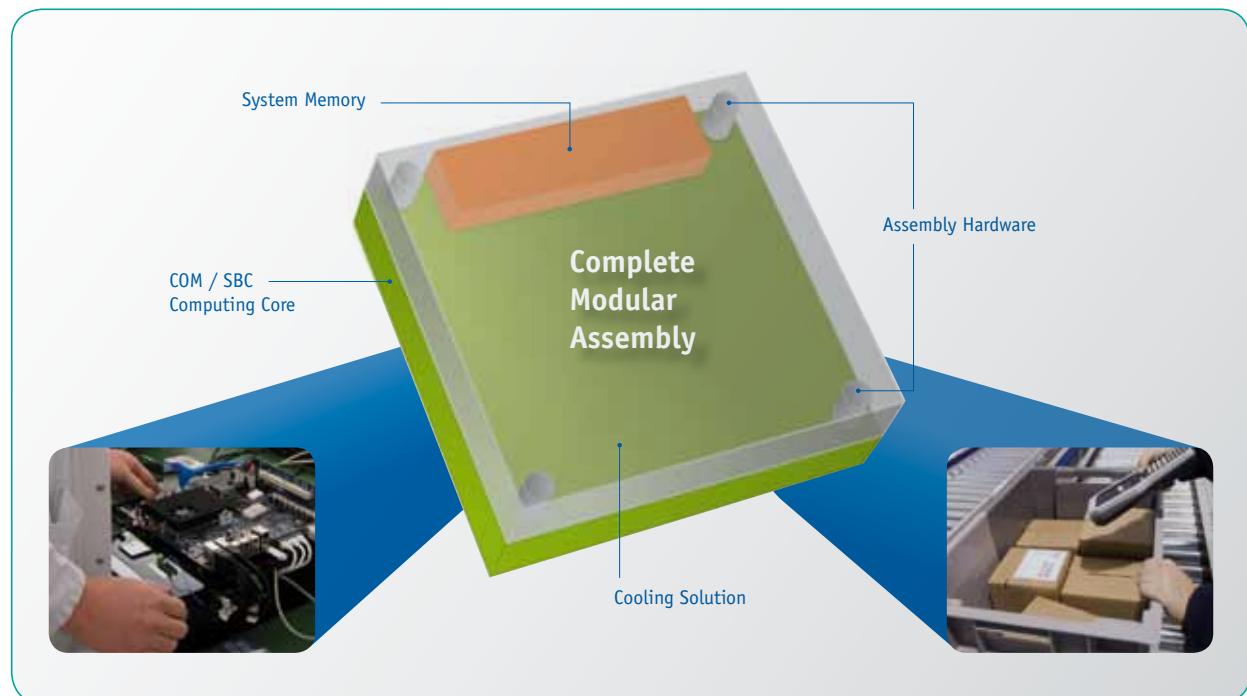
» Fast and Easy Modular PC/104 SBC-based Designs! «

Whether in the design phase or moving into production, Kontron has the tool you need and in the format you need it. Select the SBC with the computing core that matches your application, the memory and cooling solution. You don't have to worry about the memory being seated properly or whether the cooling solution is assembled to the right compression level. Kontron can take care of that for you. The Kontron product will be fully assembled and shipped to you ready to install in your lab bench fixture for quick evaluation right out of the box.

Are you going to use your solution in a harsh environment and have concerns regarding functionality at extreme temperatures? Do you want to take precautions to minimize the negative effects of moisture within your solution? Temperature screening of the entire assembly and appropriate conformal coating can be added to your complete SBC-based application solution.

Do the application-specific features of your solution require a unique splash screen or for the system to boot in a specific way when under designated conditions? Kontron can not only help you with the hardware semi-customization, but also where unique software elements are needed. BIOS, drivers, etc. – Kontron experts are available to advise and/or develop the exact pieces that you need for a perfect application match.

Now, you are ready to move your solution from the design phase and into full production. Kontron can help you simplify production by calling out the Kontron product as a single component in the bill of materials for your finished design. Kontron knows that every second counts. As your partner, we strive to make bringing your finished product to market faster and easier.





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» PC/104™, PC/104-Plus™, PCI/104-Express™, PCIe/104™ «



PCIe/104™ SBC with Intel® Atom™ processor E6x5C series

The PCIe/104™ embedded single board computer (SBC) is based on the Intel® Atom™ E600C processor series with industrial temperature range, which pairs an Intel® Atom™ E600 series processor with an Altera Field Programmable Gate Array (FPGA) in a single package. With the Intel® Atom™ E600C processor series, along with IP definable applications, the MICROSPACE® MSMST adds significant flexibility to SBC based applications. OEMs will benefit from a simplified application design, reduced development efforts, faster time to market and lower total cost of ownership.

With flexible FPGA I/O options, it allows OEMs to efficiently develop designs with the exact I/O requirements needed to address applications in markets such as automation, medical, transportation, energy, military and communications. Validated IP cores are available for CAN-bus, serial interfaces (SPI Master / UART) and PCI-Express, I2C and GPIO. This makes configuring the platform a quick and easy task. OEMs only need the required IP core and corresponding High-Speed Mezzanine Cards (HSMC) to carry out the interfaces. For further I/Os, we also offers FPGA programming services. This flexibility, combined with the x86/FPGA technology ecosystem of IP cores and HSMCs, makes it an ideal SBC for dedicated RISC platforms.

PCIe/104 CPU**MICROSPACE® MSMST**

Processor/Performance	Intel® Atom™ processor E6x5C series
I/O-Controller	Altera® Arria II GX User programmable FPGA on Intel® Atom™ processor E6x5C package
PCI Express-Bus	yes, on the bottom
HSMC-Bus	yes, on the bottom
DRAM Min-Max	soldered 512 - 2048 MB
Graphics	int. graphic controller
Storage Interface	2x SATA300
USB	2x USB2.0
Standard Temperature	0°C to +70°C
Extended Temperature	-40°C to +85°C available
Dimension	90mm x 102mm
Special Features	Arria FPGA for custom interfaces (GPIO, UART, SPI, I2C, PCI, CAN, LPT, SD, ...) on HSMC.

PC/104

For building reliable embedded PCs, we offer a broad selection of PC/104 modules. If the customer does not find the required computer module in the standard product portfolio, we will develop and manufacture a custom computer system. Complete cable sets can be delivered with all CPU modules to facilitate the customer's entry into the world of PC/104.

Advantages

- » Short development time
- » Best price-performance ratio
- » Full PC compatibility
- » Maximum system reliability
- » Extremely robust
- » Vibration resistant
- » Various processor performances
- » Space-saving

PC/104 Power Supply**MICROSPACE® MSMPS104A****MICROSPACE® MSMPS104B**

Function	Power supply	Power supply, UPS option
ISA-BUS	not mounted	not mounted
Protective Features	Reverse polarity, Fuse, Overload	Reverse polarity, Fuse, Overload
BUS Compatibility	-	-
Controller	-	Battery controller
Vinput (nom.)	12V (8V-20V)	24V, 36V, 42V, 48V (20V-55V)
1st Output	5V, 10Amp	5V, 10Amp
2nd Output	12V, 1Amp	12V, 1Amp
Power normal	75W, n=90%	75W, n=80%
Remote on/off Input	optoisolated (ignition)	optoisolated (ignition)
Power monitoring	Uin, Uout	Uin, Uout, Charger
Standard Temperature	-25°C to +60°C	-25°C to +60°C
Extended Temperature	-40°C to +85°C (reduced power to 50W)	-40°C to +85°C, (reduced power to 50W)
Dimensions (W x L in mm)	90 x 96	90 x 96
Weight	85 g	100 g
Software Support	-	UPS management
MTBF	100'000 h	100'000 h
Complies to	e1, EN60950	EN50155, IEC62040-3, e1, EN60950
Special Features	EN60950	Charger regulator interface: COM/SMB interface, Load voltage range: 20V-55V, Rechargeable battery: Pb, Pb-Gel
Accessories	Heatpipe cooler PSCS	Battery PS12BAT, Heatpipe cooler PSCS

PCI/104-Express CPUs**MICROSPACE® MSM945****MICROSPACE® MSM945P****MICROSPACE® MSM200X**

Processor/Performance	Intel® Core™ Duo L2400 / Intel® Core™2 Duo L7400 (2x 1.6 GHz / 2x 1.5 GHz)	Intel® Core™ Duo L2400 / Intel® Core™2 Duo L7400 (2x 1.6 GHz / 2x 1.5 GHz)	Intel® Atom™ Z510/Z530 (1.1/1.6 GHz)
Chipset	945GME	945GME	US15W
Bus	PCI-BUS: Option	PCI-BUS: Option, PCI Express-BUS: on the bottom	PCI-BUS: Option, PCI Express-BUS: not assembled
Memory	256-3072 MByte DRAM	512-3072 MByte DRAM	soldered 0.5-2 GByte
Video Controller	i945GME	i945GME	int. graphic Controller
Video Memory	8-224 MByte	8-224 MByte	128 MByte (UMA)
LCD Interface	SDVO	SDVO	24 bit LVDS
CRT Interface	yes	yes	yes, up to 1920 x 1200 with reduced blanking
IDE Interface P-ATA	1x	1x	1x
IDE Interface S-ATA	2x SATA 300	2x SATA 300	2x SATA 300
COM1 / COM2	RS232C / RS232C	RS232C / RS232C	RS232C / RS232C
COM3 / COM4	-	-	RS232C, RS422/485 / RS232C, RS422/485
USB	4x 2.0	4x 2.0, 2x PCI104ex	4x 2.0
Ethernet	10/100 BASE-T	10/100 BASE-T	1 Gbit LAN
Sound	HDA, 2x Stereo, SPDIF	HDA, 2x Stereo, SPDIF	HDA, 2x Stereo, SPDIF
RTC Battery onboard	80mAh (or ext. 900mAh)	80mAh (or ext. 900mAh)	900mAh (typ. 10 years)
Dimensions (W x L in mm)	90/117 x 96/99	90/117 x 96/99	90 x 102 mm
Standard Temperature	-25°C to +60°C/+70°C	-25°C to +60°C/+70°C	-25°C to +70°C
Extended Temperature	-40°C to +70°C	-40°C to +70°C	-40°C to +85°C

PCI/104-Express Peripherals**MICROSPACE® MSMGE104EX****MICROSPACE® MSM4E104EX****MICROSPACE® MSMEC104EX****MICROSPACE® MSMMI104EX****MICROSPACE® MSMSA104EX**

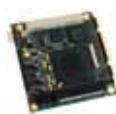
Function	1 Gbit LAN	4x 1 Gbit LAN	ExpressCard-Adapter	PCIe MiniCard adapter	2x SATA300
PCI-BUS	pass-through	pass-through	pass-through	pass-through	pass-through
PCI Express-BUS	1x Lane	1x lane	1x lane	1x lane	1x lane
BUS Compatibility	PCI/104-Express	PCI/104-Express	PCI/104-Express	PCI/104-Express	PCI/104-Express
Controller	82573L (Intel®)	4x 82574L (Intel®)	-	-	SIL 3132
1st Interface	1 Gbit LAN (RJ45)	4x 1 Gbit LAN (RJ45)	ExpressCard	PCIe MiniCard	2x SATA
2nd Interface	2x USB	-	-	SIM card	2x USB
3rd Interface	-	-	-	-	-
Power normal (typ.)	5V, 3.3V/4W	5V, 3.3V/4W	5V/3W	5V/8W	5V, 3.3V/2W
Power Management	-	-	yes	yes	-
Dimensions (W x L in mm)	90 x 96	90 x 96	90 x 96	90 x 96	90 x 96
Weight	60 g	80 g	65 g	55 g	65 g
Software Support	WINXP, Linux, VxWorks, QNX	WINXP, Linux	XP, VISTA	XP, VISTA	XP, VISTA, Linux
MTBF	100'000 h	100'000 h	100'000 h	100'000 h	200'000 h
Special Features	-	PCI-switch:PLX 8505	Hot plug support: depending on BIOS/OS	-	Bandwidth: 2x 300MByte/s, RAID 0/1
Accessories	-	-	-	WLAN-MC, GSM-MC	-
Standard Temperature	-25°C to +70°C	-25°C to +70°C	-25°C to +70°C	-25°C to +70°C	-25°C to +70°C
Extended Temperature	-	-40°C to +70°C	-	-	-

**MICROSPACE® MSM200XP****MICROSPACE® MSM200XU****PCI/104-Express CPUs**

Intel® Atom™ Z510/Z530 (1.1/1.6 GHz)	Intel® Atom™ Z510/Z530 (1.1/1.6 GHz)	Processor/Performance
US15W	US15W	Chipset
PCI-BUS: Option, PCI Express-BUS: on the bottom	PCI-BUS: Option, PCI Express-BUS: on the top	Bus
soldered 0.5-2 GByte	soldered 0.5-2 GByte	Memory
int. graphic Controller	int. graphic Controller	Video Controller
128 MByte (UMA)	128 MByte (UMA)	Video Memory
24 bit LVDS	24 bit LVDS	LCD Interface
yes, up to 1920 x 1200 with reduced blanking	yes, up to 1920 x 1200 with reduced blanking	CRT Interface
1x	1x	IDE Interface P-ATA
2x SATA 300	2x SATA 300	IDE Interface S-ATA
RS232C / RS232C	RS232C / RS232C	COM1 / COM2
RS232C, RS422/485 / RS232C, RS422/485	RS232C, RS422/485 / RS232C, RS422/485	COM3 / COM4
4x 2.0	4x 2.0	USB
1 Gbit LAN	1 Gbit LAN	Ethernet
HDA, 2x Stereo, SPDIF	HDA, 2x Stereo, SPDIF	Sound
900mAh (typ. 10 years)	900mAh (typ. 10 years)	RTC Battery onboard
90 x 102 mm	90 x 102 mm	Dimensions (W x L in mm)
-25°C to +70°C	-25°C to +70°C	Standard Temperature
-40°C to +85°C	-40°C to +85°C	Extended Temperature

**MICROSPACE® MSMFW104EX****MICROSPACE® MSMG104EX****MICROSPACE® MSMG104EX-A****MICROSPACE® MSMGS104EX****MICROSPACE® MSM8C104EX****PCI/104-Express Peripherals**

FireWire, IEEE1394B	4x Frame grabber	4x Frame grabber	GSM-UMTS	8 channel serial port	Function
pass-through	pass-through	pass-through	pass-through	pass-through	PCI-BUS
1x lane	1x lane	1x lane	1x lane	1x lane	PCI Express-BUS
PCI/104-Express	PCI/104-Express	PCI/104-Express	PCI/104-Express	PCI/104-Express	BUS Compatibility
TI	4x BT878A, PAL, NTSC	4x BT878A, PAL, NTSC	HC-25	8 ch. UART	Controller
1x IEEE1394A	16x Video, MCX (90°)	16x Video, MCX (180°)	GSM module	8 ch. RS232C (+/-9V) or	1st Interface
2x IEEE1394B	4x SVideo, MCX	4x SVideo, MCX	SIM card	8 ch. RS422 (1/8 load) or	2nd Interface
-	-	-	Headset	8 ch. RS485 (1/8 load) or	3rd Interface
5V, 3.3V/1W	5V, 3.3V/6W	5V, 3.3V/6W	5V, 3.3V/5W	5V/3W	Power normal (typ.)
12V	-	-	yes	-	Power Management
90 x 96	90 x 96	90 x 96	90 x 96	90 x 96	Dimensions (W x L in mm)
75 g	95 g	95 g	65 g	70 g	Weight
WINXP, Linux	WIN, Linux	WIN, Linux	WINXP, Linux	XP, VISTA	Software Support
200'000 h	100'000 h	100'000 h	100'000 h	200'000 h	MTBF
Bandwidth: 2.5x 800Mbit/Sek.	Bandwidth: 133MByte/sec. Max., TTL i/o, 8bit	Bandwidth: 133MByte/sec. Max., TTL i/o, 8bit	Bandwidth: (max.) HSDPA 3.6 Mb/s, GSM-Edge: Quad-band, UMTS: 850/1900/2100MHz	RS422/85:TX, RX, CTS, RTS, +/-, 8x onboard termination	Special Features
-	MSMG104EX-Cable (MCX-BNC)	MSMG104EX-Cable (MCX-BNC)	GSM/UMTS	-	Accessories
-25°C to +70°C	-25°C to +70°C	-25°C to +70°C	-25°C to +70°C	-20°C to +70°C	Standard Temperature
-40°C to +70°C	tbd	tbd	-40°C to +70°C	-40°C to +85°C	Extended Temperature

PC/104-Plus CPUs**MOPSIcdLX****MICROSPACE[®]
MSM800SEL****MICROSPACE[®]
MSM800SEV**

Processor/Performance	AMD Geode™ LX800 / 0.5GHz	AMD Geode™ LX800 / 0.5 GHz	AMD Geode™ LX800 / 0.5 GHz
Chipset	CS5536 AD	CS5536 AD	CS5536 AD
Bus	PC/104-Plus: Option	PCI-BUS: Option (3slot)	PCI-BUS: Option (3slot)
Memory	128-1024 MByte	128-1024 MByte	128-1024 MByte
Video Controller	int. graphic Controller	int. graphic Controller	int. graphic Controller
Video Memory	16MB (UMA)	16 MByte (UMA)	16 MByte (UMA)
LCD Interface	24bit, 320x240 to 1600x1200	24 bit, 320x240 to 1600x1200	24 bit, 320x240 to 1600x1200
CRT Interface	yes	yes	yes
IDE Interface P-ATA	1x EIDE (UDMA-33)	1x	1x
IDE Interface S-ATA	-	-	-
COM1 / COM2	RS232C / RS232C	RS232C / RS232C	RS232C / RS232C
USB	2x 2.0	4x 2.0	4x 2.0
Ethernet	10/100 BASE-T	10/100 BASE-T	10/100 BASE-T
Sound	-	-	AC97
RTC Battery onboard	-	-	400mAh
Dimensions (W x L in mm)	90 x 96	90 x 99	90 x 99
Special Features	Lan Boot, Watchdog, JIDA-Support, JRC-Support, Dark Boot, 32 MB - 1GB, chipDISK	-	-
Standard Temperature	0°C to +60°C	0°C to +60°C	0°C to +60°C
Extended Temperature	-	-25°C to +70°C	-25°C to +70°C

PC/104-Plus Peripherals**MICROSPACE[®]
MSMCA104+****MICROSPACE[®]
MSMCA104+ISOL****MICROSPACE[®]
MSMG104+**

Function	CAN	CAN	Video frame grabber
PCI-BUS	yes	yes	yes
PCI Express-BUS	-	-	-
BUS Compatibility	PC/104-Plus	PC/104-Plus	PC/104-Plus
Controller	Peak-CAN	Peak-CAN	BT878A
Memory	-	-	-
1st Interface	CAN DSUB9, CiA DS102-1	CAN DSUB9, CiA DS102-1	1st channel CVBS
2nd Interface	CAN DSUB9, CiA DS102-1	CAN DSUB9, CiA DS102-1	2nd channel CVBS
3rd Interface	-	-	3rd channel CVBS /SVideo
Power normal (typ.)	3.3V/5V/2W	3.3V, 5V/4W	5V/2W
Dimensions (W x L in mm)	90 x 96	90 x 96	90 x 96
Weight	80 g	30 g	35 g
Software Support	Win, Linux	Win, Linux	WIN, CE, Linux
MTBF	200'000 h	200'000 h	200'000 h
Special Features	Reset using software commands	500V isolated, Reset using software commands	Digital I/O, PAL, NTSC
Standard Temperature	-25°C to +70°C	-25°C to +70°C	-25°C to +70°C
Extended Temperature	tbd	tbd	-40°C to +85°C



MICROSPACE® MSM800BEV	MICROSPACE® MSM800XEL	MICROSPACE® MSM800EV	MICROSPACE® MSM200S	PC/104-Plus CPUs
AMD Geode™ LX800 / 0.5 GHz	AMD Geode™ LX800 / 0.5 GHz	AMD Geode™ LX800 / 0.5 GHz	Intel® Atom™ Z510/Z530 (1.1/1.6 GHz)	Processor/Performance
CS5536 AD	CS5536 AD	CS5536 AD	US15W	Chipset
PCI-BUS: Option (3slot)	PCI-BUS: Option (2slot)	PCI-BUS: Option (2slot)	PCI-BUS: Option, ISA: yes (8 bit / no DMA / no Interrupt)	Bus
128-1024 MByte	soldered 256 MByte	soldered 256 MByte	soldered 0.5-2 GByte	Memory
int. graphic Controller	int. graphic Controller	int. graphic Controller	int. graphic Controller	Video Controller
16 MByte (UMA)	16 (UMA)	16 (UMA)	128 (UMA)	Video Memory
24 bit, 320x240 to 1600x1200	24 bit, 320x240 to 1600x1200	24 bit, 320x240 to 1600x1200	24 bit LVDS	LCD Interface
yes	yes	yes	yes, up to 1920x1200 with reduced blanking	CRT Interface
1x	1x	1x	1x	IDE Interface P-ATA
-	-	-	2x SATA300	IDE Interface S-ATA
RS232C / RS232C	RS232C / RS232C	RS232C / RS232C	RS232C, RS422/485 / RS232C, RS422/485	COM1 / COM2
4x 2.0	4x 2.0	4x 2.0	6x 2.0	USB
10/100 BASE-T	10/100 BASE-T	10/100 BASE-T	1 GBit LAN	Ethernet
AC97	-	AC97	HDA (ALC882-7.1), 2x Stereo, SPDIF	Sound
400mAh	-	400mAh (typ. 5 years)	900mAh (typ. 10 years)	RTC Battery onboard
90 x 99	90 x 99	90 x 99	90 x 102 mm	Dimensions (W x L in mm)
-	soldered RAM	soldered RAM	-	Special Features
0°C to +60°C	0°C to +60°C	0°C to +60°C	-25°C to +70°C	Standard Temperature
25°C to +70°C, -40°C to +85°C (with large cooler and E48 or with thermo junction and E48)	25°C to +70°C, -40°C to +85°C (with large cooler and E48 or with thermo junction and E48)	25°C to +70°C, -40°C to +85°C (with large cooler and E48 or with thermo junction and E48)	25°C to +70°C, -40°C to +85°C	Extended Temperature



MICROSPACE® MSMW104+	MICROSPACE® MSMX104+	MICROSPACE® MSME104+	MICROSPACE® MSMGE104+	PC/104-Plus Peripherals
FireWire	8x serial	Ethernet LAN	1Gigabit-LAN	Function
yes	yes	yes	yes	PCI-BUS
-	-	-	-	PCI Express-BUS
PC/104-Plus	PC/104-Plus	PC/104-Plus	PC/104-Plus	BUS Compatibility
TSB43AB22	EXAR 17C158	i82551	i82541	Controller
-	-	32 kByte	32 kByte	Memory
IEEE 1394 A	8ch RS232C	RJ45	RJ45	1st Interface
IEEE 1394 A	8ch RS422	-	-	2nd Interface
-	8ch RS485	-	-	3rd Interface
3.3V/3W	3.3V/3W	3.3V/1W	3.3V/2W	Power normal (typ.)
90 x 96	90 x 96	90 x 96	90 x 96	Dimensions (W x L in mm)
70 g	70 g	70 g	70 g	Weight
WIN, Linux	WIN, Linux	WIN, CE, Linux	WIN, Linux	Software Support
>200'000 h	>200'000 h	200'000 h	100'000 h	MTBF
-	8x 10pin header	10/100 BASE-T	-	Special Features
-25°C to +70°C	-25°C to +70°C	-25°C to + 70°C	-25°C to + 70°C	Standard Temperature
-40°C to +70°C	-40°C to +85°C	-40°C to + 85°C	-40°C to + 85°C	Extended Temperature



» The MICROSPACE® computer systems market segment «

Kontron manufactures specially designed computer systems for its target markets that optimally and individually satisfy the application profiles of these specific markets. As such, reliable operation with high availability (high MTBF) is a must-have.

» Industrial market

The MICROSPACE® computer systems for the industrial market cover applications for measurement engineering, for industrial automation and control, and include data capture for stationary information terminals (POI). Power supply is through the 12V or 24V PLC or with a power adaptor (110/220VAC). Mounting possibilities include desktop, DIN top-hat rails, 19-inch or wall mounts.



MPC20



MPC21B



MPCV800



MPCF50



» Rail market

The MICROSPACE® computer systems for rail applications fulfill the EN50155 rail standard and function on inputs of 24VDC to 110VDC. Additionally, certified and insulated power supply packs are used (voltage code I24-I110). Paired with an appropriate SSD mass storage device, these computers function in extreme environments where temperatures range from -40 to +85 degrees Celsius. All fittings are coded and lockable. The temperatures and voltages are monitored and logged. Redundant supplies, interfaces and battery buffering are options. These computers include optional GPS, GSMUMTS and WLAN.



MPCX28R



MPCR50R

» Vehicular market

MICROSPACE® computer systems for mobile use in vehicles (battery input of 12V, 24V, 28V, 42V) have E1 certification and function in a broad temperature range. The input power packs coded V1248 are especially protected in vehicular environments (overcurrent, overvoltage, current reduction at motor start, reverse polarity protection). Special automotive hard disks, CompactFlash or solid-state drives are used as mass storage devices. These computers include optional GPS, GSM-UMTS and WLAN.



MPCX28



» The EN50155 certified railway computer! «



Ruggedized and fanless for gateway, passenger entertainment and passenger safety

Designed for the extended temperature range from -25 to 70 °C and in a rugged profiled-aluminum case, the passively-cooled Railway Box-PC is based on the 1.6 GHz Intel® Atom™ processor Z530 with 533 MHz FSB and supports up to 1GB of DDR2 RAM. The integrated graphics chipset offers 256MB of video memory as well as support for DirectX 9 3D and HDTV. Plus, the integrated MPEG2 and H.264 decoders reduce processor load while displaying HD video.

Both the bay for one 2.5-inch SATA 300 hard drive or SSD as well as the slot for Compact Flash media are easily

accessible from the front. This makes this compact and ready to install Box PC system particularly well-suited for passenger infotainment or security applications because saved media can easily be exchanged simply by swapping out the storage device. Furthermore, for customer-specific extensions, the robust Railway Box PC features a PCI/104 expansion slot for ultra-thin and space-saving PCI/104 expansion cards. Application-specific enhancements such as dual-CAN, GPS, GSM/UMTS or WLAN can easily be integrated via two PCI Express® Mini Card slots. An eSATA port also allows for the use of an external data storage medium to further extend storage capacity.

**MICROSPACE®
Railway**
**MPCX28R****MPCR50R**

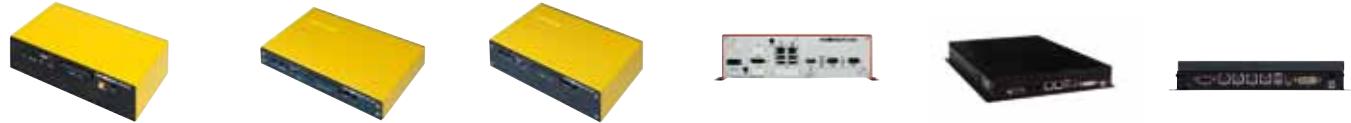
Processor/Performance	Intel® Atom™ Z530 (1.6 GHz) Option: 2.5" 80 GByte or 32 GByte SSD	Intel® Core™ Duo L2400 / Intel® Core™2 Duo L7400 (2x 1.6 GHz / 2x 1.5 Ghz) 80 GByte 2.5" or 32 GByte SSD
HDD	Option	yes
CompactFlash	1 GByte DDR2	up to 3GByte
Memory	1600 x 1200 (UXGA)	2048x1536 (QXGA)
Graphics/Resolution	DVI-D, opt. VGA	VGA
Video Interface 1	-	DVI
Video Interface 2	RS232C, RS422/485 (DSUB9) / RS232, RS422/485 (DSUB9)	RS232 (DSUB9) / RS323 (DSUB9)
COM1 / COM2	-	RS232, CAN (DSUB9) / RS232, CAN (DSUB9)
COM3 / COM4	2x 2.0 front, 2x 2.0 back, 1x 2.0 (M12) back	2x 2.0 front, 1x 2.0 (M12) front
USB	10/100 BASE-T (M12), with LAN boot, WakeOnLan	10/100 BASE-T (M12) with LAN boot
LAN Port A	10/100 BASE-T (M12), WakeOnLan	1 Gbit-LAN (RJ45) with LAN boot
LAN Port B	2x Stereo (Mic.line)	2x Stereo 10W, 1x Stereo In
Sound	4x DC-isolated in-/output	4x opto output, 4x opto input
Digital Input/Output	10-54VDC/typ.15W	8-58VDC/typ.40W
DC voltage input (not isol.), V1248	24/36/48/72/110VDC/typ.15W	24/36/48/72/110VDC/typ.40W
DC voltage input (1.5kV isol.), Ixx	2x PCIe Mini Card, 1x PCI/104	2x PCIEexpress MiniCard, 1x PCI/104express slot, 1x PCI ExpressCard slot
Expansion	IP52, EN50155	IP40, EN50155
Protection class	159 x 190 x 66	480 x 132 x 250
Dimensions (W x L x H in mm)	1,6 kg	6 kg
Weight	WakeOnLan, RingWake, WakeOnRing, PowerSaveMode	-
Special Features	-25°C to +55°C (T1) (with HD)	-25°C to +55°C (T1) (with HD)
Standard Temperature	-25°C to +70°C (T3) (with SSD)	-40°C to +85°C (TX) (with SSD)
Extended Temperature		

**MICROSPACE®
Vehicle**
**MPCX28**

Processor/Performance	Intel® Atom™ Z530 (1.6 GHz) (Option: 2.5" 80 GByte or 32 GByte SSD)
HDD	Option
CompactFlash	1 GByte DDR2
Memory	1600 x 1200 (UXGA)
Graphics/Resolution	DVI-D
Video Interface 1	Customer specific DVI-A
Video Interface 2	RS232C, RS422/485 (DSUB9) / RS232C, RS422/485 (DSUB9)
COM1 / COM2	2x 2.0 back, 2x 2.0 front
USB	1 Gbit (RJ45) with LAN boot, WakeOnLan
LAN Port A	1 Gbit (RJ45)
LAN Port B	2x Stereo (Mic. line)
Sound	4x DC-isolated in-/output
Digital Input/Output	10-54VDC/typ.15W
DC voltage input (not isol.), V1248	2x PCIEexpress MiniCard, 1x PCI/104
Expansion	IP52
Protection class	159 x 187 x 66
Dimensions (W x L x H in mm)	1,5 kg
Weight	WakeOnMove, RingWake, WakeOnRing, PowerSaveMode
Special Features	-25°C to +55°C (with HD)
Standard Temperature	-25°C to +70°C (with SSD, no HD)
Extended Temperature	

**MICROSPACE®
Industrial**
**MPC20****MPC20L****MPC21****MPC21A****MPC21B**

Processor/Performance	AMD Geode™ LX800 (0.5 Ghz)	AMD Geode™ LX800 (0.5 Ghz)	AMD Geode™ LX800 (0.5 Ghz)	AMD Geode™ LX800 (0.5 Ghz)	AMD Geode™ LX800 (0.5 Ghz)
HDD	Optional	Optional	Optional	Optional	Optional
CompactFlash	CF 256 MByte installed	socket (type I/II)	CF 256 MByte installed	CF 256 MByte installed	CF 256 MByte installed
Memory	256 (max. 1 GByte)	256 (max. 1 GByte)	256 (max. 1 GByte)	256 (max. 1 GByte)	256 (max. 1 GByte)
	int. graphic Controller / UXGA	int. graphic Controller / UXGA	int. graphic Controller / UXGA	int. graphic Controller / UXGA	int. graphic Controller / UXGA
Video Interface 1	CRT	CRT	CRT	CRT	CRT
Video Interface 2	-	-	-	-	-
COM1 / COM2	-	-	RS232C (DSUB9) / -	RS232C (DSUB9) / RS232 (DSUB9)	RS232C (DSUB9) / RS232 (DSUB9)
COM3 / COM4	-	-	-	RS232C (DSUB9) / RS232C (DSUB9)	CAN1 (DSUB9) / CAN2 (DSUB9)
USB	4x 2.0 (1x internal)	4x 2.0 (1x internal)	4x 2.0 (1x internal)	4x 2.0 (1x internal)	4x 2.0 (1x internal)
LAN Port A	10/100 BASE-T	10/100 BASE-T	10/100 BASE-T	10/100 BASE-T	10/100 BASE-T
LAN Port B	10/100 BASE-T	-	10/100 BASE-T	10/100 BASE-T	10/100 BASE-T
Sound	2x Stereo	2x Stereo	2x Stereo	2x Stereo	2x Stereo
Digital Input/Output	-	-	-	4x opto isol. 50V/1A	-
DC voltage input (not isol.), V1248	10V-28V/typ.10W	10V-28V/typ.10W	10V-28V/typ.10W	10V-28V/typ.10W	10V-28V/typ.10W
DC voltage input (1.5kV isol.), Ixx	-	-	-	-	-
Expansion	-	-	-	-	-
Protection class	-	-	-	-	-
Dimensions (W x L x H in mm)	165 x 110 x 27	165 x 110 x 27	165 x 110 x 46	165 x 110 x 46	165 x 110 x 46
Weight	500 g	500 g	700 g	700 g	700 g
Special Features	fanless, incl. DC power cable	fanless	MiniPCI-socket, PCI/104-slot, incl. DC power cable	MiniPCI-socket, incl. DC power cable	MiniPCI-socket, incl. DC power cable
Standard Temperature	0°C to +50°C (with HD)	0°C to +50°C (with HD)	0°C to +50°C (with HD)	0°C to +50°C (with HD)	0°C to +50°C (with HD)
Extended Temperature	-25°C to +70°C (without HD)	-25°C to +70°C (without HD)	-25°C to +70°C (without HD)	-25°C to +70°C (without HD)	-25°C to +70°C (without HD)



MPC21	MPC25	MPC26	MPCV800	MPCF50	MPCF50A
AMD Geode™ LX800 (0.5 GHz)	Intel® Atom™ Z510 (1.1 GHz)	Intel® Atom™ Z510 (1.1 GHz)	AMD Geode™ LX800 (0.5 Ghz)	Intel® Core™ Duo L2400 / Intel® Core™2 Duo L7400 (2x 1.6 GHz / 2x 1.5 Ghz)	Intel® Core™ Duo L2400 / Intel® Core™2 Duo L7400 (2x 1.6 GHz / 2x 1.5 Ghz)
Optional	Optional	Optional	160 GByte, 2.5"	320 GByte (SATA)	320 GByte (SATA)
CF 256 MByte installed	CF 256MB installed	CF 256MB installed	-	-	-
256 (max. 1 GByte)	1GB soldered	1GB soldered	512 MByte	1 GByte (max. 2 GByte), (max. 3 GByte)	1 GByte (max. 2 GByte), (max. 3 GByte)
int. graphic Controller / UXGA	int. graphic Controller / QXGA	int. graphic Controller / QXGA			
CRT	DVI-D	DVI-D	CRT	CRT	CRT
-	-	-	-	DVI	DVI
RS232C (DSUB9) / RS232 (DSUB9)	-	RS232/RS232	RS232C / RS232C	-	-
-	-	-	-	-	-
4x 2.0 (1x internal)	6x 2.0 (of which 1x internal)	6x 2.0 (of which 1x internal)	4x 2.0	6x 2.0	6x 2.0
10/100 BASE-T	1Gbit (PCIe)	1Gbit (PCIe)	10/100 BASE-T	10/100 BASE-T (RJ45) with LAN boot	10/100 BASE-T (RJ45) with LAN boot
10/100 BASE-T	10/100 BASE-T	10/100 BASE-T	1 Gbit	1x 1 Gbit	3x 1 Gbit
2x Stereo	2x Stereo	2x Stereo	-	2x Stereo	-
-	-	-	24 programmable I/O	-	-
-	10V-28V/typ.12W	10V-28V/typ.12W	-	-	-
-	-	-	-	-	-
-	PCIexpress MiniCard	PCIexpress MiniCard	MiniPCI, PC/104-Plus (max. 2 cards)	MiniPCI	PCIexpress MiniCard
-	-	-	IP40	IP40	IP40
165 x 110 x 46	165 x 110 x 27	165 x 110 x 46	292 x 146 x 83	310 x 256 x 42	310 x 256 x 42
700 g	500 g	500 g	3 kg	3 kg	3 kg
MiniPCI-socket, PCI/104-slot, incl. DC power cable	fanless	fanless	Videointerface 3: LVDS, 18 bit	3D-Support: DirectX9	3D-Support: DirectX9
0°C to +50°C (with HD) -25°C to +70°C (without HD)	0°C to +40°C (with HD) -25°C to +50°C (without HD)	0°C to +40°C (with HD) -25°C to +50°C (without HD)	+5°C to +50°C (with HD) -25°C to +70°C (with SSD/CF)	+5°C to +50°C (with HD) -25°C to +70°C (with SSD)	+5°C to +50°C (with HD) -25°C to +70°C (with SSD)



kontron

About Kontron

Kontron is a global leader in embedded computing technology. With more than 30% of its employees in Research and Development, Kontron creates many of the standards that drive the world's embedded computing platforms. Kontron's product longevity, local engineering and support, and value-added services, helps create a sustainable and viable embedded solution for OEMs and system integrators. Kontron works closely with its customers on their embedded application-ready platforms and custom solutions, enabling them to focus on their core competencies. The result is an accelerated time-to-market, reduced total-cost-of-ownership and an improved overall application with leading-edge, highly-reliable embedded technology.

Kontron is listed on the German TecDAX stock exchange under the symbol "KBC".
For more information, please visit: www.kontron.com

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